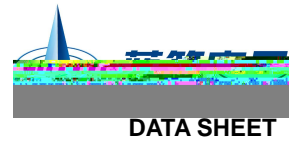


/ Revised record

A	2021.04.18	All	AOS-AONS32306		
B	2021.05.26	2	PK632BA	ID PD	
			Rth		
A	2022-8-2	all	Q	AEC-Q101	
			5°C	Q 245±	
				5±0.5sec	
				255±5°C	
				5±0.5sec	

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/ Descriptions

PDFN5×6 N
N-Channel MOSFET in a PDFN5×6 Plastic Package.

/ Features

AEC-Q101

Low $R_{DS(ON)}$ to minimize conductive loss; low Gate Charge for fast switching; Low Thermal resistance; Qualified to AEC-Q101 Standards for High Reliability; HF Product.

/ Applications

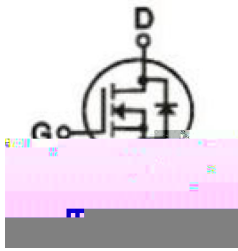
MB/NB/UMPC/VGA

Buck

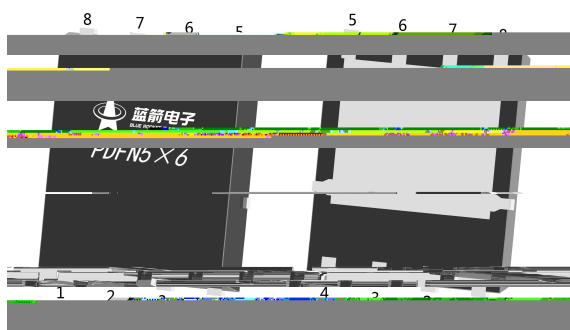
-

Battery Management, High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA, Networking DC-DC Power System, Load Switch, Meet the stringent requirements of automotive applications.

/ Equivalent Circuit



/ Pinning

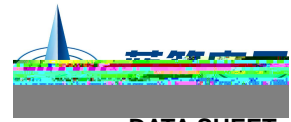


PIN1、2、3: S PIN4: G PIN5、6、7、8: D

Pin	极性
1	S
2	S
3	S
4	G
5	D
6	D
7	D
8	D

/ Marking

。 See Marking Instructions.



/ Absolute Maximum Ratings(T_a=25)

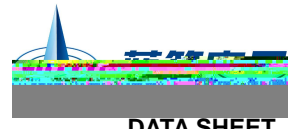
Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DS}	30	V
Continuous Drain Current	I _D	56	A
Pulsed Drain Current	I _{DM}	168	A
Gate-Source Voltage	V _{GS}	± 20	V
Power Dissipation	P _D (T _c =25)	33	W
Avalanche energy(L=0.5mH)	E _{AS}	72	mJ
Avalanche Current(L=0.5mH)	I _{AS}	36	A
Junction and Storage Temperature Range	T _j , T _{stg}	-55 to 150	°C
Maximum Junction-to-Ambient	t 10s	30	°C/W
	Steady-State	54	
Maximum Junction-to-Case	Steady-State	3.8	

/ Electrical Characteristics(T_a=25)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250uA, V _{GS} =0V	30	31		V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V, V _{GS} =0V			1.0	uA
Gate-Body leakage current	I _{GSS}	V _{DS} =0V, V _{GS} = ±20V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	1	1.8	2.5	V
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =20A		2.9	3.1	mΩ
		V _{GS} =4.5V, I _D =10A		4.1	4.8	
Diode Forward Voltage	V _{SD}	I _S =1A, V _{GS} =0V		0.68	1	V
Input Capacitance	C _{iss}	V _{DS} =25V V _{GS} =0V f=1.0MHz		3030		pF
Output Capacitance	C _{oss}			355		
Reverse Transfer Capacitance	C _{rss}			260		
Gate resistance	R _g	V _{GS} =0V V _{DS} =0V f=1MHz		3		
Total Gate Charge	Q _{g(10V)}	V _{GS} =10V, V _{DS} =15V, I _D =20A		63		nC
Total Gate Charge	Q _{g(4.5V)}			29		
Gate Source Charge	Q _{gs}			9.0		
Gate Drain Charge	Q _{gd}			9.5		

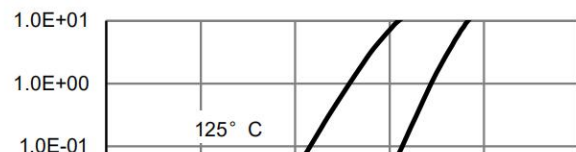
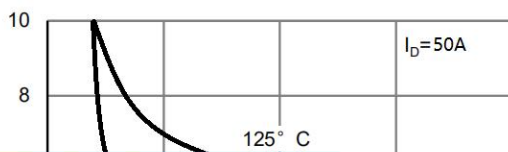
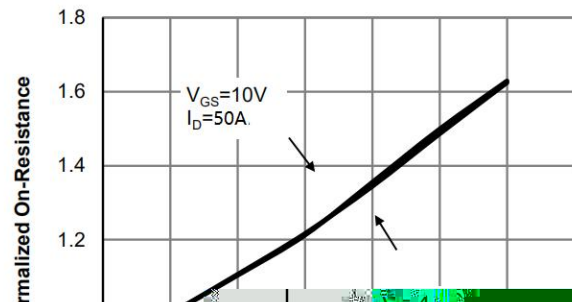
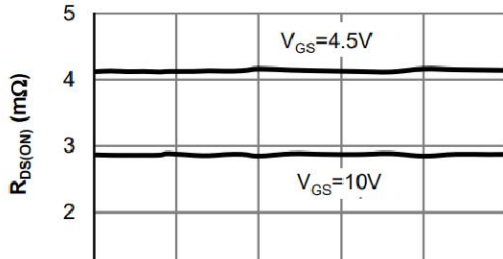
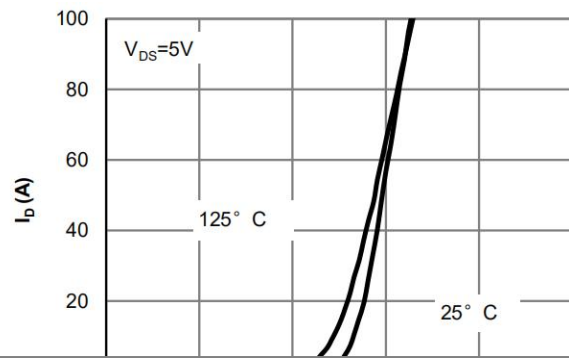
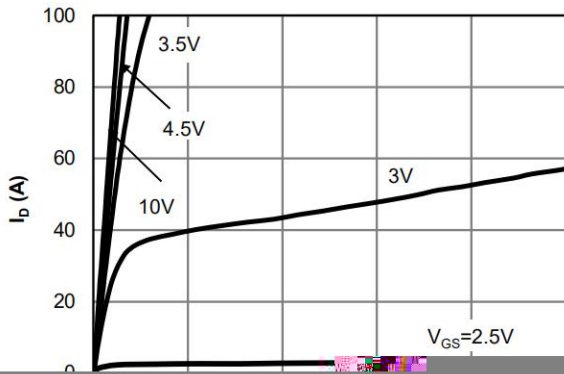
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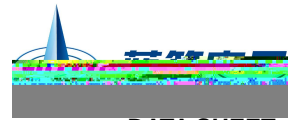
Rev.A Aug.-2022



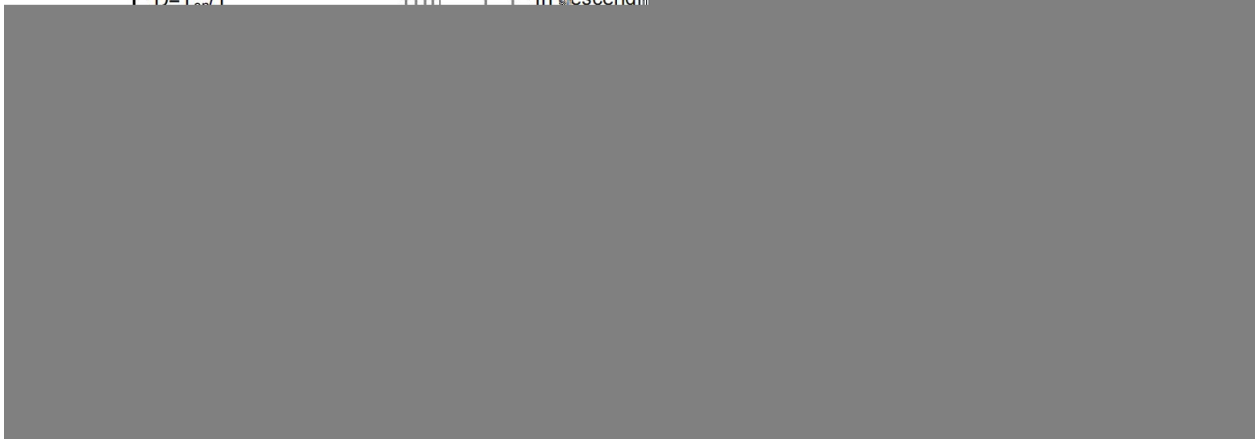
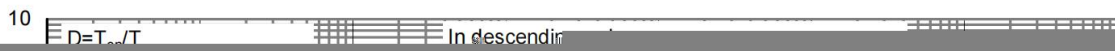
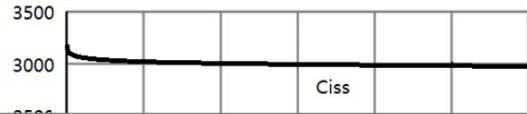
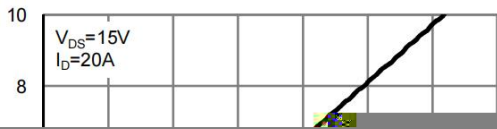
DATA SHEET

/ Electrical Characteristic Curve

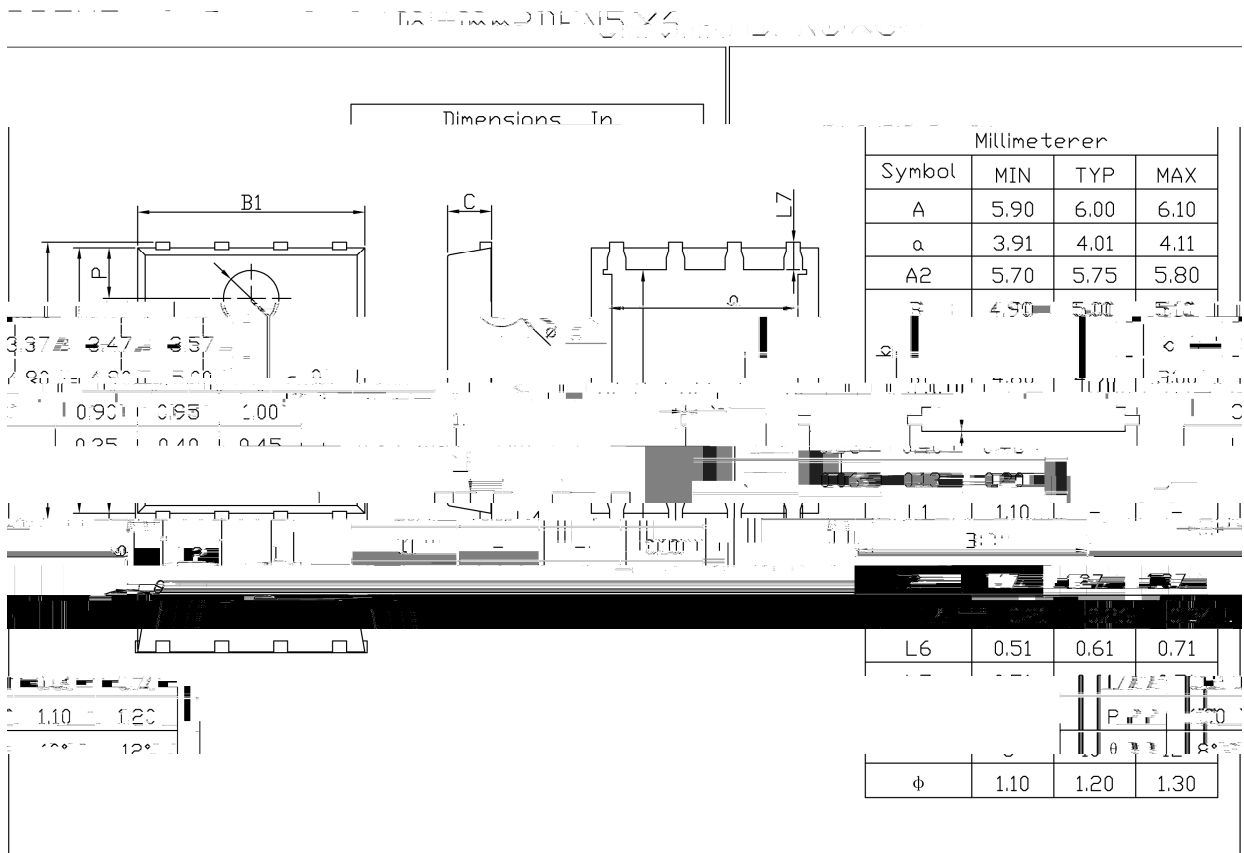




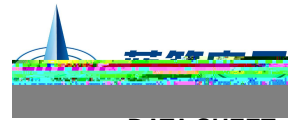
/ Electrical Characteristic Curve



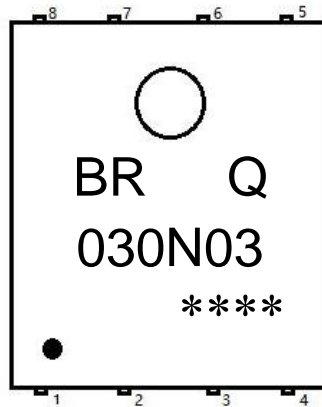
/ Package Dimensions



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/ Marking Instructions



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Q

030N03

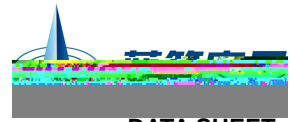
Note

BR Company Code

Q: Automobile halogen-free product Code

030N03 Product Type

****: Lot No. Code, code change with Lot No



() / Temperature Profile for IR Reflow Soldering(Pb-Free)

Note:

- 1 150 200 60 120sec; 1.Preheating:150~200°C, Time:60~120sec.
- 2 255±5 5±0.5sec; 2.Peak Temp.:255±5°C, Duration:5±0.5sec.
- 3